

Vítejte na O-leaderu

Společnost O-Leading se snaží být vaším partnerem pro řešení na jednom místě v dodavatelském řetězci EMS, včetně návrhu PCB, výroby PCB a montáže PCB (PCBA). Poskytujeme některé z nejpokročilejších technologií PCB, včetně HDI PCB, vícevrstvých PCB, pevných PCB. Můžeme podporovat od rychlého otočení prototypu po střední a hromadnou výrobu.

Naši globální zákazníci jsou obecně našimi službami velmi ohromeni: rychlá odezva, konkurenceschopná cena a závazek kvality. Poskytování cennějších technických služeb a celkového řešení je cesta vedoucí k O. [, Vlastní obvodové desky Čína](#)

Při pohledu do budoucnosti se O-leader soustředí na inovace a vývoj technologie výroby elektroniky jako vždy a vytrvale usiluje o jednorázovou službu PCB a PCBA s cílem poskytovat prvotřídní služby a vytvářet větší hodnotu pro naše zákazníky.

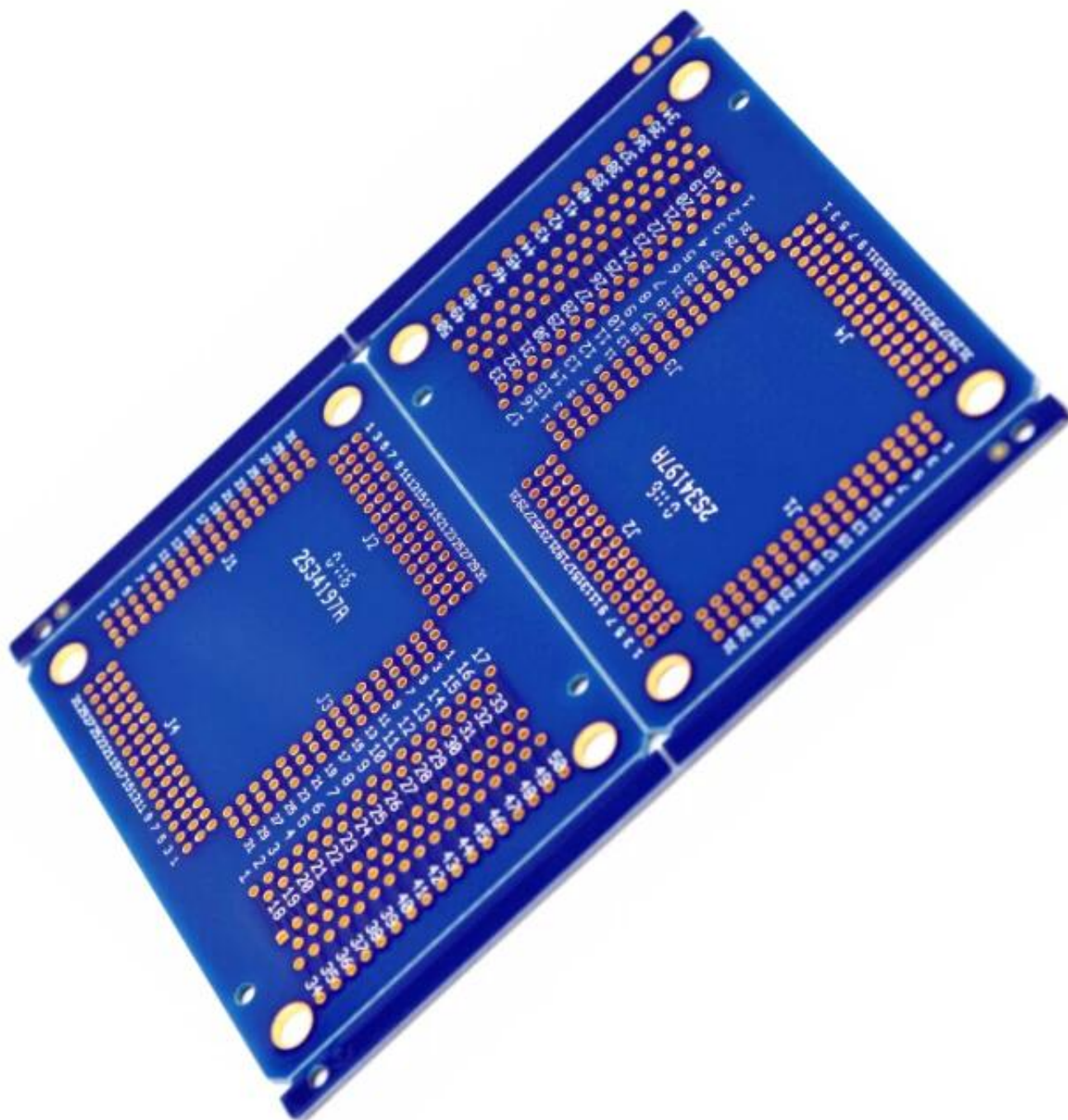
Rychlé informace

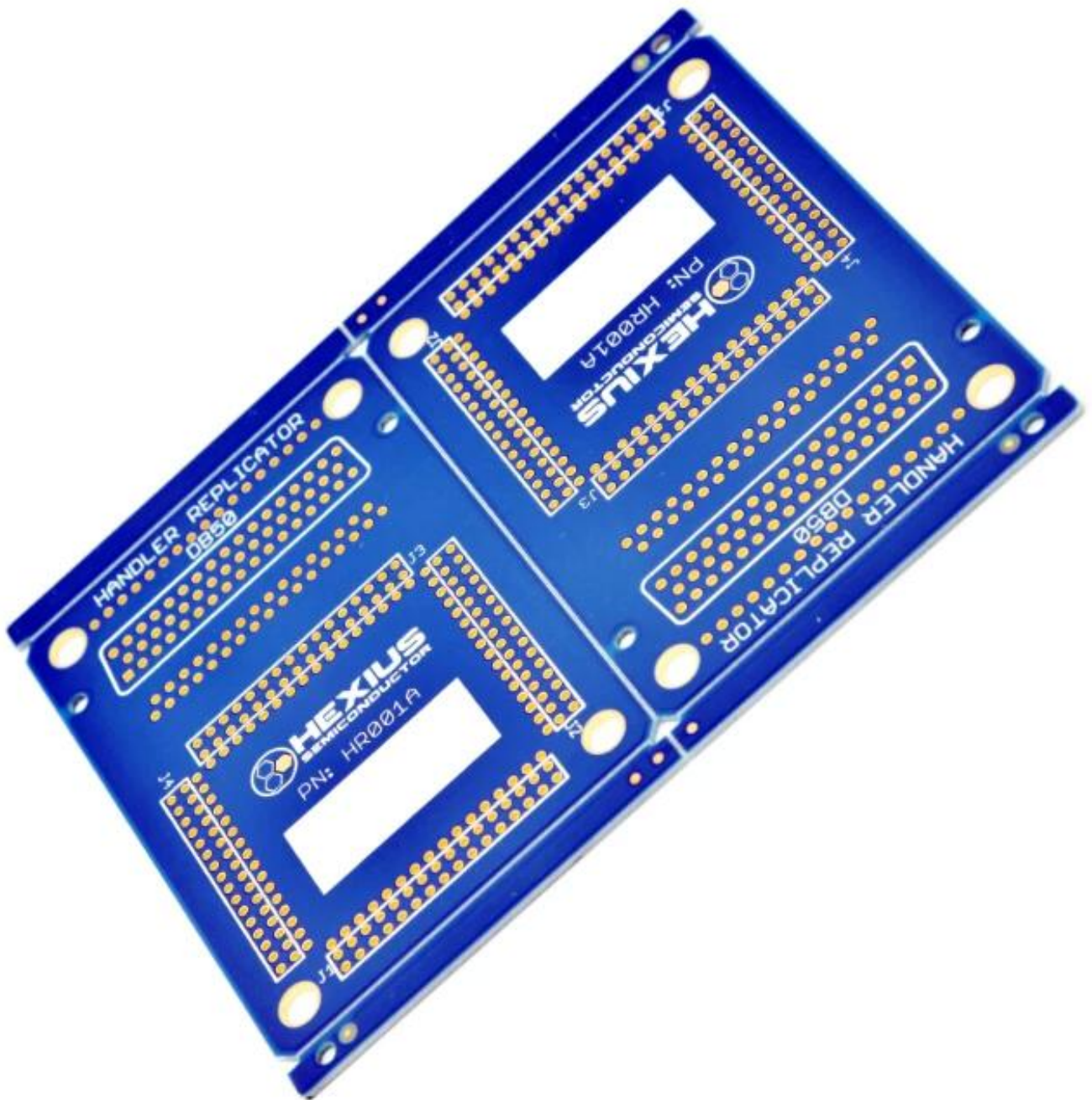
Místo původu	Guang dong, Čína (pevnina)	Jméno značky	O-vedoucí
Základní materiál	FR-4, Hliník	Tloušťka mědi	0,5oz-5oz
Min. Velikost otvoru	0,2 mm	Min. Šířka čáry	0,2 mm
Povrchová úprava	imerzní zlato, OSP, HASL bez obsahu olova	Tloušťka desky	0,1 - 5 mm
použitelné pro	led, mobilní telefon, klimatizace, pračky	charakter	Průmyslová kontrola pcb
certifikáty	ISO9001, UL, RoHS, SGS	Q / CTN	10PCS-100PCS
hmotnost	0,01 kg -5 kg	MOQ	10ks
Modelové číslo	PowerBank pcb montáž pcba výrobce	Min. Řádkování	0,2 mm
barva	modrá, červená, zelená, černá	cena	0,1-10 \$
tupý typ	požadavek klienta	velikost	0,01 m3 - 10 m3

16 let profesionální výroba desek plošných spojů OEM

položka	2014		2015 ~ 2016		2017 ~ 2018	
	Objem	Vzorek	Objem	Vzorek	Objem	Vzorek
Počet vrstev	32	42	38	44	42	48
Min. Řádek / mezera (µm)	50/50	40/45	40/45	40/40	35/40	35/35
Min vrtací otvor průměr (mm)	0,15	0,10	0,15	0,10	0,15	0,10
Poměr stran PTH	14: 1	16: 1	16: 1	18: 1	18: 1	20: 1
N + C + N	4 + C + 4	5 + C + 5	5 + C + 5	6 + C + 6	5 + C + 5	6 + C + 6
Jakékoli propojení vrstev	5 + 2 + 5	6 + 2 + 6	5 + 2 + 5	6 + 2 + 6	5 + 2 + 5	6 + 2 + 6
Plnění destiček přes	ANO	-	ANO	-	ANO	-
Min. tloušťka jádra (kromě mědi) (µm)	50	40	40	30	40	30

Min. Průměr laserového vrtáku (μm)	75	65	65	50	50	40
Na pohřben díra / naskládaná prostřednictvím	ANO	-	ANO	-	ANO	-
Materiál	FR4, Megtron, Nelco, Rogers, těžká měď atd.					
Vestavěný kondenzátor PCB	ANO	-	ANO	-	ANO	-
Povrchový proces	Bezolovnatý HASL, ENIG, OSP, imerzní stříbro, iminzní cín, Bleskové zlato, Pokovování zlatým prstem, Selektivní tvrdé pokovování, Odlupovací pájecí maska, uhlíkový inkoust					





[Výrobce malých objemů plošných spojů](#)

Náš tým



Factory PCB



Automatic vacuum press machine



Drilling Machine



Pattern Plating Machine



Scrubbing Machine



Developing Machine



Routing Machine



High-speed flying probe machine



E-test Machine

Factory SMT



Certifikace

CICC INSPECTION CERTIFICATION



嘉泰认证

QUALITY MANAGEMENT SYSTEM CERTIFICATE

Certificate No: 18118Q10347R05

We hereby certify that

O-LEADING SUPPLY CHAIN(HK) CO.,LIMITED

Credit No: 61691591-000-07-18-7

Registration Add: FLAT/RM 1205 12/F TAI SANG BANK BUILDING 130-132 DES VODEUS ROAD CENTRAL HK

Business Add: 1213, Floor 13, Fortune Building, Danshui Town, Huiyang District, Huizhou, Guangdong, China

Has implemented and maintains a **Quality Management System** Which fulfills the requirements of the following standards
GB/T19001-2016 idt ISO9001:2015

Scope of certification
Sales of printed circuit boards

Initial issuance period: February 27, 2018
Renewal date: April 22, 2019
This certificate is valid during: April 22, 2019 – February 26, 2021
This certificate is invalid without CICC qualified label in the following period

First supervision and audit	Second supervision and audit	Qualified mark
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The certification registration number does not include those production stages which fail to be covered by the relevant effective administrative procedures and qualification procedures mentioned in the scope. The effectiveness of this certificate shall be restricted to actual surveillance scope of CICC the certificate shall be valid also used together with the surveillance with reference.

The initial issuance of this certification can be searched on the portal of CICC www.cicc.com.cn by the site of inquiry www.cicc.com.cn.






CICC INSPECTION CERTIFICATION



嘉泰认证

质量管理体系认证证书

证书号: 18118Q10347R05

兹证明

诚领供应链(香港)有限公司

统一社会信用代码: 61691591-000-07-18-7

注册地址: 香港中環德輔道中130-132號大生銀行大廈1205室

经营地址: 广东惠州惠阳淡水南亨西路财富大厦13楼1313

建立的质量管理体系符合
GB/T19001-2016 idt ISO9001:2015 质量标准适用条款的要求

认证范围
印刷线路板的销售

初次获证日期: 2018年02月27日
换证日期: 2019年04月22日
证书有效期: 自2019年04月22日至2021年02月26日
在下列期限内, 未经CICC黏贴合格标贴, 本证书无效

第一次监督	第二次监督	黏贴处
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Test Report

No. SZXEC1900530401 Date: 30 Mar 2019 Page 1 of 6

O-LEADING SUPPLY CHAIN (HK) CO., LIMITED

1313.FLOOR 13, FORTUNE BUILDING, DANSHUI TOWN, HUIYANG DISTRICT, HUIZHOU, GUANGDONG, CHINA

The following sample(s) was/were submitted and identified on behalf of the clients as : OSP

SGS Job No. : RP19-005089 - SZ
Date of Sample Received : 22 Mar 2019
Testing Period : 22 Mar 2019 - 30 Mar 2019
Test Requested : Selected test(s) as requested by client.
Test Method : Please refer to next page(s).
Test Results : Please refer to next page(s).

Conclusion : Based on the performed tests on submitted sample(s), the results of Lead, Mercury, Cadmium, Hexavalent chromium, Polybrominated biphenyls (PBBs), Polybrominated diphenyl ethers (PBDEs) and Phthalates such as Bis(2-ethylhexyl) phthalate (DEHP), Butyl benzyl phthalate (BBP), Dibutyl phthalate (DBP), and Diisobutyl phthalate (DIBP) comply with the limits as set by RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU.

Signed for and on behalf of
SGS-CSTC Standards Technical Services Co., Ltd. Shenzhen Branch

Tina
Tina Fan
Approved Signatory



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Test Report

No. SZXEC1900530401 Date: 30 Mar 2019 Page 2 of 6

Test Results :

Test Part Description :

Table with 3 columns: Specimen No., SGS Sample ID, Description. Row 1: SN1, SZX19-005304.001, Green"PCB"

Remarks :

- (1) 1 mg/kg = 1 ppm = 0.0001%
(2) MDL = Method Detection Limit
(3) ND = Not Detected (< MDL)
(4) "-" = Not Regulated

RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU

Test Method : With reference to IEC 62321-4:2013+A1:2017, IEC 62321-5:2013, IEC 62321-7-2:2017, IEC 62321-6:2015 and IEC 62321-8:2017, analyzed by ICP-OES, UV-Vis and GC-MS.

Table with 5 columns: Test Item(s), Limit, Unit, MDL, 0/1. Lists various substances like Cadmium, Lead, Mercury, Hexavalent Chromium, Sum of PBBs, etc. with their respective limits and detection results.



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ZPMV2.E490354 - WIRING, PRINTED - COMPONENT

Wiring, Printed - Component

See General Information for Wiring, Printed - Component

O-LEADING SUPPLY CHAIN (HK) CO LTD

E490354

ROOM 1205, 12/F
TAI SANG BANK BLDG
130-132 DES VOEUS ROAD
CENTRAL, HONG KONG

Type	Cond Width		Cond Thk	SS/ DS/ DSO	Max	Max		Meets	C		
	Min	Edge			Area	Solder	Oper			Flame	
	mm(in)	mm(in)	mic(mil)		Diam	Limits	Temp	Class	UL796	T	
Multilayer (mass laminate) printed wiring boards.											
O-LEADING-401	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	12.7 (0.5)	260	10	130	V-0	-	-
O-LEADING-407	0.08 (0.003)	0.2 (0.008)	17 (0.67)	DS	9.7 (0.4)	260	10	130	V-0	All	-
Multilayer printed wiring boards.											
O-LEADING-408	0.125 (0.005)	0.125 (0.005)	12 (0.47) Int:136	DS	50.8 (2.0)	280	20	130	V-0	All	*
Single layer printed wiring boards.											
O-LEADING-002	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	105	V-0	All	-
O-LEADING-003	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	130	V-0	▲	-
O-LEADING-033	0.15 (0.006)	0.3 (0.012)	34 (1.34)	SS	25.4 (1.0)	260	10	120	V-0	All	-
O-LEADING-205	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING-206	0.15 (0.006)	0.33 (0.013)	17 (0.67)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING-D01	0.14 (0.006)	0.15 (0.006)	33 (1.30)	DS	25.4 (1.0)	260	10	130	V-0	All	*
O-LEADING-S01	0.25 (0.010)	0.25 (0.010)	17 (0.67)	SS	25.4 (1.0)	260	4	130	V-0	All	*

WIRING, PRINTED - COMPONENT | UL Product iQ

O-LEADING-S02	0.2 (0.008)	0.2 (0.008)	17 (0.67)	SS	25.4 (1.0)	260	4	130	HB	▲	*
O-LEADING-S03	0.25 (0.010)	0.25 (0.010)	34 (1.34)	SS	25.4 (1.0)	260	4	130	V-0	All	*

* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.

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Shipping service



Quick Turn Lead Time		
Layer Count:	Lead Tim	Special Requirement
1L/2L	2-3days	24 Hours,48 Hours
4L	3-4days	48 Hours
6L	4-5days	72 Hours
8L	5-6days	NA
10L	6-7days	NA
12L	7-8days	NA
14L	8-9days	NA

Standard Lead Time		
Layer Count:	Sample Lead Time	Volume order lead time
2L	4 days	10 days
4L	5 days	11 days
6L	6 days	12 days
8L	8 days	14 days
10L	10 days	16 days
12L	12 days	18 days
14L	14 days	20 days
16-32L	18 days	24 days

Schopnost procesu

Schopnosti výroby PCB

Počet vrstev: 1Layer-32Layer

Konečná tloušťka mědi □ 1 / 3oz-12oz

Min Šířka / mezera interní internal 3,0 mil / 3,0 mil

Min Šířka / rozteč linek externí: 4,0 mil / 4,0 mil

Maximální poměr stran: 10: 1

Tloušťka desky □ 0,2 mm - 5,0 mm

Maximální velikost panelu (palce): 635 x 1500 mm

Minimální velikost vrtané díry: 4 mil

Tolerance plated Hole: +/- 3mil

Blind / Buried Vias (typy All): ANO

Prostřednictvím výplně (vodivé, nevodivé): ANO

Základní materiál: FR-4, FR-4high Tg.Halogenový materiál, Rogers, Hliníková základna,Polyimid,

Těžká měď

Povrchové úpravy: HASL, OSP, ENIG, HAL-LF, Immersion silver,Immersion Cín, Zlaté prsty, Uhlíkový inkoust

Výrobní schopnosti SMT

Materiál DPS: FR-4, CEM-1, CEM-3, deska na bázi hliníku
Maximální velikost DPS: 510 x 460 mm
Minimální velikost DPS □ 50x50 mm
Tloušťka DPS □ 0,5 mm - 4,5 mm
Tloušťka desky □ 0,5-4 mm
Minimální velikost komponent: 0201
Standardní součást velikosti čipu: 0603 a větší
Maximální výška komponenty □ 15 mm
Min. Stoupání olova: 0,3 mm
Min. Rozteč kuliček BGA: 0,4 mm
Přesnost umístění: +/- 0,03 mm